

# AP20P02GJ-VB Datasheet P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$V_{DS}(V)$ $R_{DS(on)}(\Omega)$		Q <sub>g</sub> (Typ.)			
- 30	0.056at V <sub>GS</sub> = - 10 V	- 20	19 nC			
- 30	$0.072$ at $V_{GS} = -4.5$ V	- 15	19110			

#### **FEATURES**

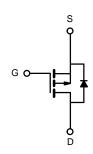
- Halogen-free
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested



ROHS

#### **APPLICATIONS**

- Load Switch
- · Notebook Adaptor Switch



P-Channel MOSFET

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0		
		Drain Connected to Drain-Tab
G D	S	
Top Vie	w	

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage	$V_{GS}$	± 20	v		
	T <sub>C</sub> = 25 °C		- 20		
Continuous Drain Current (T. – 150 °C)	T <sub>C</sub> = 70 °C		- 15		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-7.9 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 5.6 <sup>a, b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	- 60	A		
Continuous Course Danie Diada Current	T <sub>C</sub> = 25 °C		- 20		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls =	- 7.9 <sup>a, b</sup>		
Avalanche Current Single-Pulse Avalanche Energy L = 0.1 mH		I <sub>AS</sub>	- 20		
		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		20		
Martinera Barras Biochaetha	T <sub>C</sub> = 70 °C		15	10/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.7 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C		1.7 <sup>a, b</sup>		
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	$R_{thJA}$	38	46	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	20	25	C/VV	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on  $T_C$  = 25 °C.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	<sub>DS</sub> /T <sub>J</sub> I <sub>D</sub> = - 250 µA		- 34		mV/
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- 1D = - 250 μΑ		5.3		°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1.4		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 100	nA
Zoro Coto Voltogo Droin Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 20			Α
David Course On Otata Basista and	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6 A	0.056			Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4 A		0.072		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 6 A		28		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			1150		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		205		
Reverse Transfer Capacitance	$C_{rss}$	1		140		
Total Cata Chausa	Qg	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6 A		27	43	nC
Total Gate Charge				19	25	
Gate-Source Charge	$Q_gs$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6 \text{ A}$		6		
Gate-Drain Charge	$Q_{gd}$			12		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	2.2	4.4	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			13	25	
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		12	24	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		40	70	
Fall Time	t <sub>f</sub>	]		9	18	,,
Turn-On Delay Time	t <sub>d(on)</sub>			48	80	ns
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		92	160	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -6 \text{ A}, \ V_{GEN} = -4.5 \text{ V}, \ R_g = 1 \ \Omega$		34	60	
Fall Time	t <sub>f</sub>			19	35	
<b>Drain-Source Body Diode Characteris</b>	tics					
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.1	Α
Pulse Diode Forward Current	I <sub>SM</sub>				- 60	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			27	45	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	]   _ 6		16	27	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		12		-
Reverse Recovery Rise Time	t <sub>b</sub>			15		ns

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

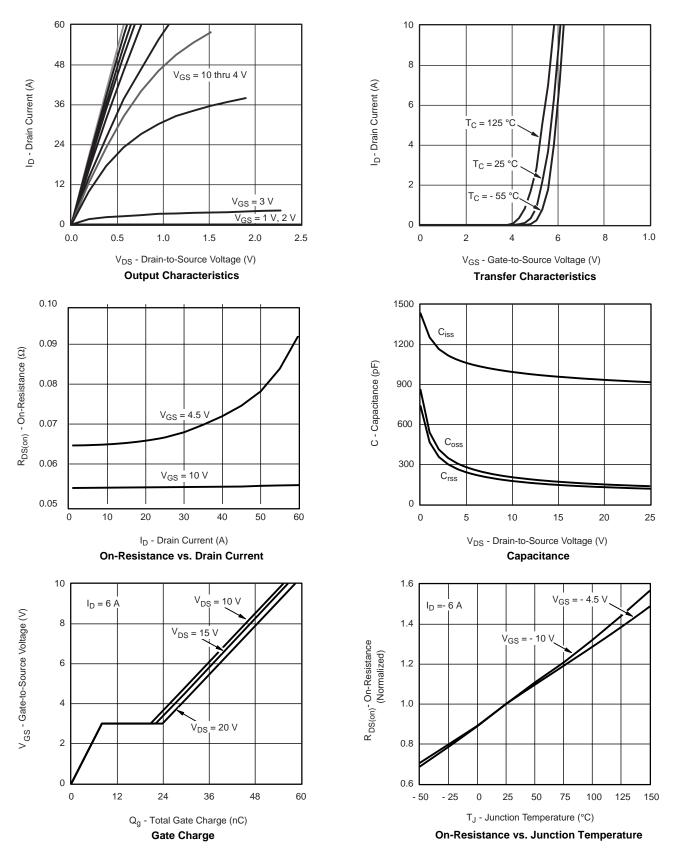
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a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

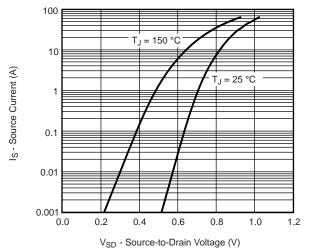


# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

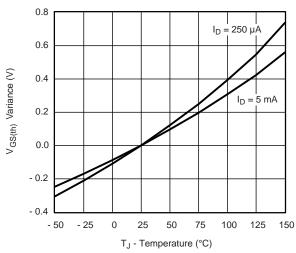




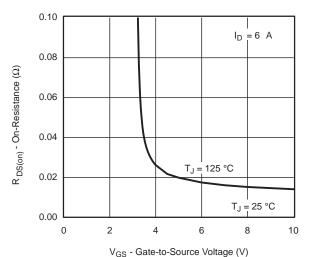
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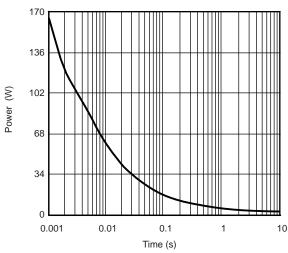
#### Source-Drain Diode Forward Voltage



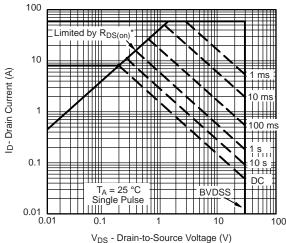
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

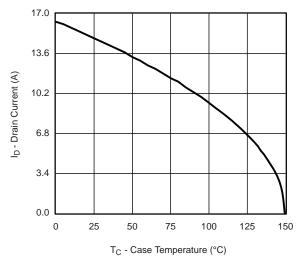


V<sub>DS</sub> - Drain-to-Source voltage (V)
 V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

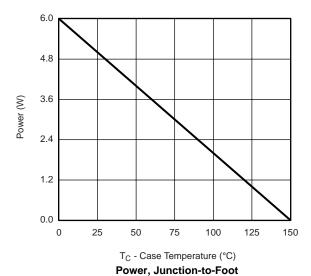
Safe Operating Area

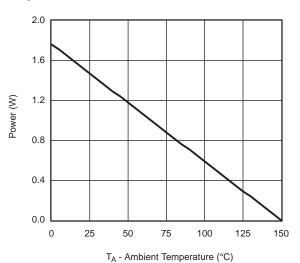


# MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



## **Current Derating\***





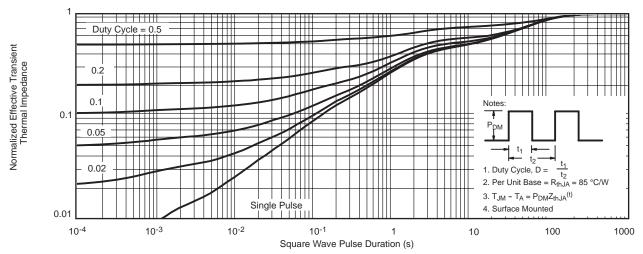
Power Derating, Junction-to-Ambient

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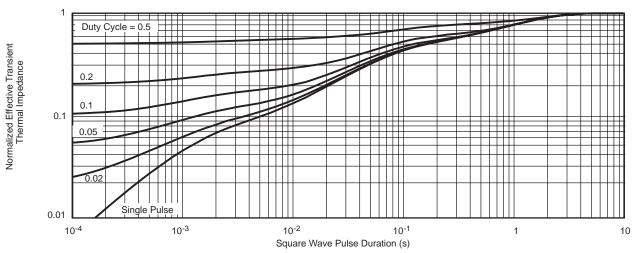
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package



# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



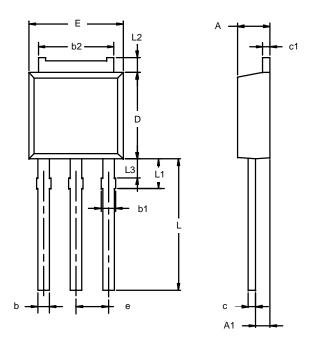
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



## **TO-251AA**



Note: Dimension L3 is for reference only.

	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
<b>A</b> 1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060

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